



DuPont™ Kapton® HPP-ST

Polyimide Film

Description

DuPont™ Kapton® HPP-ST is a two-sided, treated film that offers the same excellent balance of physical, chemical, and electrical properties over a wide temperature range offered by general purpose Kapton® HN. Additionally, this high performance film has superior dimensional stability and excellent adhesion with most adhesion systems. Adhesion data for HPP-ST can be referenced in the adhesion to Kapton® technical bulletin.

In applications where low shrinkage and superior adhesion are important, Kapton® HPP-ST is the polyimide film of choice.

Applications

- Electronic parts
- PCB stencils
- Screen printing
- Insulation tubing

Product Specifications

Kapton® HPP-ST is manufactured, slit and packaged according to the product specifications listed in H-38479 (6/18).

Certification

Kapton® HPP-ST meets ASTM D-5213 (type 1, item A) requirements.

Table 1 – Typical Properties of Kapton® HPP-ST at 23°C (73°F)

Property	Unit	1 mil 25µm	2 mil 50µm	3 mil 75µm	5 mil 125µm	Test Method
Physical						
Tensile Strength	kpsi (MPa)	33.5 (231)	34 (234)	34 (234)	33.5 (231)	ASTM D-882-91
Elongation	%	72	72	78	82	ASTM D-882-91
Tensile Modulus	kpsi (GPa)	400 (2.8)	400 (2.8)	400 (2.8)	400 (2.8)	ASTM D-882-91
Adhesion	pli (N/mm)	10 (1.8)	10 (1.8)	10 (1.8)	10 (1.8)	IPC-TM-650 Method 2.4.9*
Density	g/cc	1.42	1.42	1.42	1.42	ASTM D-1505-90
MIT Folding Endurance	cycles	285,000	55,000	6,000	3,000	ASTM D-2176-89
Tear Strength-propagating (Elmendorf), N		0.07	0.21	0.38	0.58	ASTM D-1922-89
Tear Strength, initial (Graves), N		7.2	16.3	26.3	46.9	ASTM D-1004-90
Thermal						
Flammability		94V0	94V0	94V0	94V0	UL-94
Shrinkage (30 min at 150°C) Method 2.2.4A	%	0.03	0.03	0.03	0.03	IPC-TM-650
Limiting Oxygen Index	%	37	43	46	45	ASTM D-2863-87
Electrical						
Dielectric Strength	kV/mil (kV/mm)	7.7 (303)	6.1 (240)	5.1 (201)	3.9 (154)	ASTM D-149-91
Dielectric Constant	1kHz	3.4	3.4	3.5	3.5	ASTM D-150-92
Dissipation Factor at 1 kHz		0.0018	0.0020	0.0020	0.0026	ASTM D-150-92
Volume Resistivity	ohm-cm	1.5 x 10 ¹⁷	1.5 x 10 ¹⁷	1.4 x 10 ¹⁷	1.0 x 10 ¹⁷	ASTM D-257-91

Acrylic adhesive to 1 oz. copper

Table 2 – Physical Properties of Kapton® HPP-ST Film

Property	Typical Value at		Test Method
	23°C (73°F)	200°C (392°F)	
Yield Point at 3%, MPa (psi)	69 (10,000)	41 (6000)	ASTM D-882-91
Stress to produce 5% elongation, MPa (psi)	90 (13,000)	62 (9000)	ASTM D-882-91
Impact Strength, N·cm· (ft lb)	78 (0.58)		DuPont Pneumatic Impact Test
Coefficient of Friction, kinetic (film-to-film)	0.48		ASTM D-1894-90
Coefficient of Friction, static (film-to-film)	0.63		ASTM D-1894-90
Refractive Index (sodium D line)	1.70		ASTM D-542-90
Poisson's Ratio	0.34		Avg. three samples Elongated at 5%, 7%, 10%
Low Temperature Flex Life	pass		IPC-TM 650, Method 2.6.18

Table 3 – Thermal Properties of DuPont™ Kapton® HPP-ST Film

Thermal Property	Typical Value	Test Condition	Test Method
Melting Point	None	None	ASTM E-794-85 (1989)
Thermal Coefficient of Linear Expansion	20 ppm/°C (11 ppm/°F)	-14 to 38°C (7 to 100°F)	ASTM D-696-91
Coefficient of Thermal Conductivity, $\frac{W}{m \cdot K}$ $\frac{cal}{cm \cdot sec \cdot ^\circ C}$	0.12 2.87 x 10 ⁴	296 K 23°C	ASTM F-433-77 (1987)
Specific Heat, J/g·K (cal/g·°C)	1.09 (0.261)		Differential calorimetry
Heat Sealability	not heat sealable		
Solder Float	pass		IPC-TM-650, method 2.4.13A
Smoke Generation	D _m =<1	NBS smoke chamber	NFPA-258
Glass Transition Temperature (Tg)	A second order transition occurs in Kapton® between 360°C(680°F) and 410°C(770°F) and is assumed to be the glass transition temperature. Different measurement techniques produce different results within the above temperature range.		

Table 4 – Electrical Properties of Kapton®HPP-ST Film at 23°C (73°F)

Property Film Gauge	Typical Value		Test Condition	Test Method
Dielectric Strength	V/m kV/mm	(V/mil)		
25 µm (1 mil)	303	(7700)	60 Hz	ASTM D-149-91
50 µm (2 mil)	240	(6100)	1/4 in electrodes	
75 µm (3 mil)	201	(5100)	500 V/sec rise	
125 µm (5 mil)	154	(3900)		
Dielectric Constant				
25 µm (1 mil)	3.4		1 kHz	ASTM D-150-92
50 µm (2 mil)	3.4			
75 µm (3 mil)	3.5			
125 µm (5 mil)	3.5			
Dissipation Factor				
25 µm (1 mil)	0.0018		1 kHz	ASTM D-150-92
50 µm (2 mil)	0.0020			
75 µm (3 mil)	0.0020			
125 µm (5 mil)	0.0026			
Volume Resistivity	$\Omega \cdot cm^{17}$			
25 µm (1 mil)	1.5 x 10 ¹⁷			ASTM D-257-91
50 µm (2 mil)	1.5 x 10 ¹⁷			
75 µm (3 mil)	1.4 x 10 ¹⁷			
125 µm (5 mil)	1.0 x 10 ¹⁷			

Dimensional Stability

The dimensional stability of DuPont™ Kapton® polyimide film depends on two factors—the normal coefficient of thermal expansion and the residual stresses placed in the film during manufacture. The latter causes Kapton® to shrink on its first exposure to elevated temperatures as indicated in the bar graph in **Figure 1**. Once the film has been exposed, the normal values of the thermal coefficient of linear expansion as shown in **Table 5** can be expected.

Residual Shrinkage vs. Exposure Temperature and Thickness, Kapton® HN and HPP-ST Films

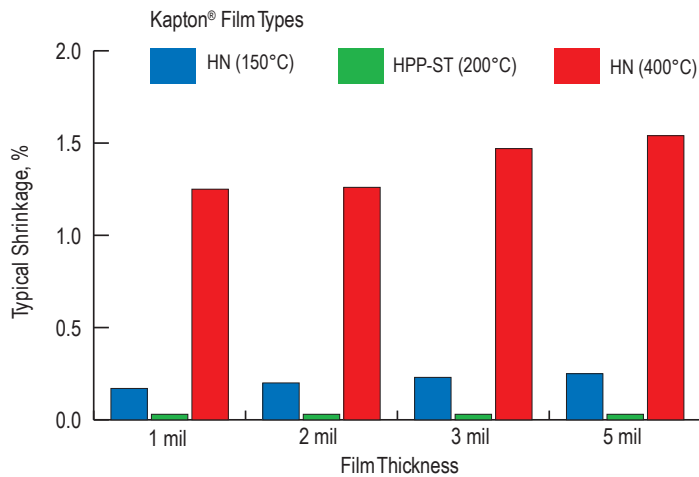


Table 5 – Thermal Coefficient of Expansion, Kapton® HPP-ST Film, 25 µm (1 mil), Thermally Exposed

Temperature Range, °C, (°F)	ppm/°C
30–100 (86–212)	17
100–200 (212–392)	32
200–300 (392–572)	40
300–400 (572–752)	44
30–400 (86–752)	34



For more information on DuPont™ Kapton® or other DuPont products, please visit our website.

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